

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
<b>CONVEYING PARTY DATA</b>																	
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<b>CORRESPONDENCE DATA</b>																	

Fax Number:

*Correspondence will be sent via US Mail when the fax attempt is unsuccessful.*

Phone: 97236114100

Email: patents@friedpat.com

Correspondent Name: Mark M.Friedman

Address Line 1: 7 Jabotinski St.

Address Line 2: Moshe Aviv Towers 54th Floor

Address Line 4: Ramat Gan, ISRAEL 52520

ATTORNEY DOCKET NUMBER:	5513/1
NAME OF SUBMITTER:	Mark M Friedman
Signature:	/MMF/
Date:	06/27/2013

Total Attachments: 2

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ASSIGNMENT OF APPLICATION

Docket: \_\_\_\_\_

I/We, WEI, Xing; WANG, Zhongdang; YE, Fei; CAO, Gongbai; LIN, Chenglu; ZHANG, Miao; WANG, Xi, whose residence and post office address is as stated below next to my/our name, hereafter referred to as applicant, have invented certain new and useful improvements in

METHOD FOR PREPARING SEMICONDUCTOR SUBSTRATE WITH INSULATING BURIED LAYER BY GETTERING PROCESS

for which an application for a United States Patent was filed on \_\_\_\_\_

Serial No. \_\_\_\_\_

for which an application for a United States Patent was executed on 6/22/2013

and

Whereas, SHANGHAI SIMGUI TECHNOLOGY CO., LTD., a corporation of China herein referred to "assignee" whose mailing address is 200 Puhui Road, Jiading Shanghai 201821 China, and SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION TECHNOLOGY, CHINESE ACADEMY OF SCIENCES a corporation of China herein referred to "assignee" whose mailing address is 865 Changning Road, Changning Shanghai 200051 China, are desirous of acquiring the entire right, title and interest in the same;

Now, therefore, in consideration of the sum of one dollars (\$1.00), the receipt whereof is acknowledged, and other good and valuable consideration, We/I, the applicant, by these presents do sell, assign and transfer unto said assignee the full and exclusive right to the said invention in the United States and the entire right, title and interest in and to any and all Patents which be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

6/22/2013

Executed on \_\_\_\_\_

WEI Xing

Name: WEI, Xing

Address: 200 Puhui Road, Jiading Shanghai 201821 China

SH100958-US/TP130309-US

*Wang Zhongdang*

Name: WANG, Zhongdang  
Address: 200 Puhui Road, Jiading Shanghai 201821 China

*Ye Fei*

Name: YE, Fei  
Address: 200 Puhui Road, Jiading Shanghai 201821 China

*Cao Gonghai*

Name: CAO, Gonghai  
Address: 200 Puhui Road, Jiading Shanghai 201821 China

*Lin Chenglu*

Name: LIN, Chenglu  
Address: 200 Puhui Road, Jiading Shanghai 201821 China

*Miao Zhang*

Name: ZHANG, Miao  
Address: 200 Puhui Road, Jiading Shanghai 201821 China

*Wang Xi*

Name: WANG, Xi  
Address: 200 Puhui Road, Jiading Shanghai 201821 China

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